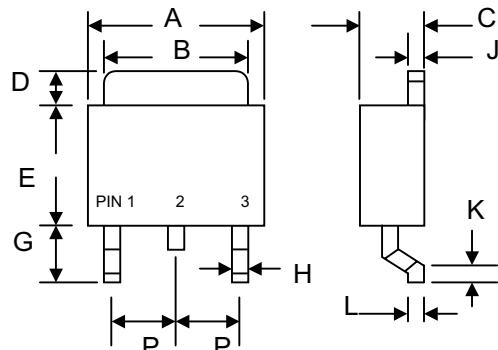


## Data Sheet 2604 Rev.—

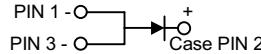
## Features

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Profile Package
- High Surge Current Capability
- Low Power Loss, High Efficiency
- Super-Fast Recovery Time
- Plastic Case Material has UL Flammability Classification Rating 94V-O



## Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-750, Method 2026
- Polarity: Cathode Band
- Weight: 0.4 grams (approx.)
- Mounting Position: Any
- Marking: Type Number
- Standard Packaging: 16mm Tape (EIA-481)



D PAK/TO-252AA		
Dim	Min	Max
A	0.252(6.40)	0.268(6.80)
B	0.197(5.00)	0.213(5.40)
C	0.093(2.35)	0.108(2.75)
D	—	0.063(1.60)
E	0.209(5.30)	0.224(5.70)
G	0.091(2.30)	0.106(2.70)
H	0.016(0.40)	0.031(0.80)
J	0.016(0.40)	0.024(0.60)
K	0.012(0.30)	0.028(0.70)
L	0.020(0.50) Typical	
P	—	0.091(2.30)
All Dimensions in inch( mm)		

Maximum Ratings and Electrical Characteristics @ $T_A=25^\circ\text{C}$  unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	ED302YS	ED303YS	ED304YS	ED306YS	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	300	400	600	V
RMS Reverse Voltage	$V_R(\text{RMS})$	140	210	280	420	V
Average Rectified Output Current @ $T_L = 75^\circ\text{C}$	$I_o$		3.0			A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$			75		A
Forward Voltage (Note 1) @ $I_F = 3.0\text{A}$	$V_{FM}$	0.95		1.25	1.7	V
Peak Reverse Current @ $T_A = 25^\circ\text{C}$ At Rated DC Blocking Voltage @ $T_A = 100^\circ\text{C}$	$I_{RM}$			5.0 200		$\mu\text{A}$
Typical Thermal Resistance Junction to Ambient	$R_{\theta JA}$		80			K/W
Reverse Recovery Time (Note 2)	$t_{rr}$		35			$\text{nS}$
Operating and Storage Temperature Range	$T_j, T_{STG}$		-50 to +150			$^\circ\text{C}$

Note: 1. Mounted on P.C. Board with  $14\text{mm}^2$  (0.13mm thick) copper pad.

2. Measured with  $I_F = 0.5\text{A}$ ,  $I_R = 1.0\text{A}$ ,  $I_{rr} = 0.25\text{A}$ .

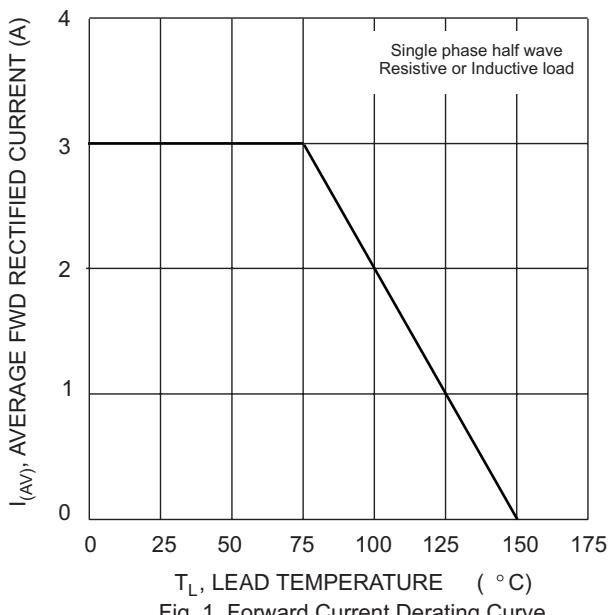


Fig. 1 Forward Current Derating Curve

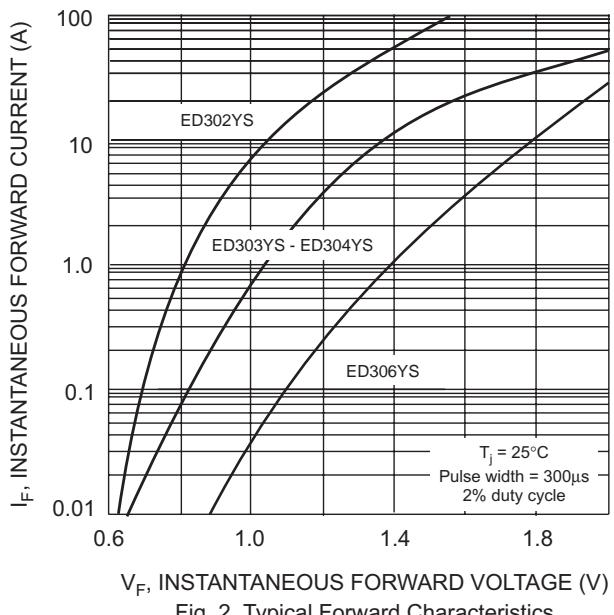


Fig. 2 Typical Forward Characteristics

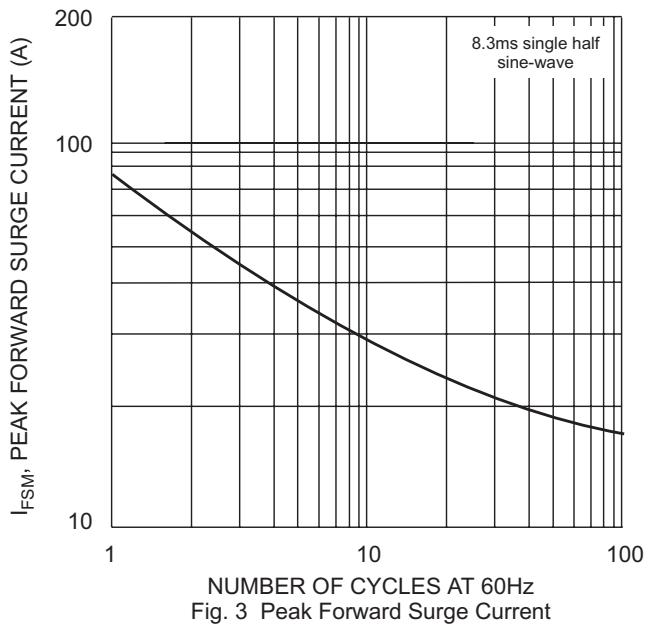


Fig. 3 Peak Forward Surge Current

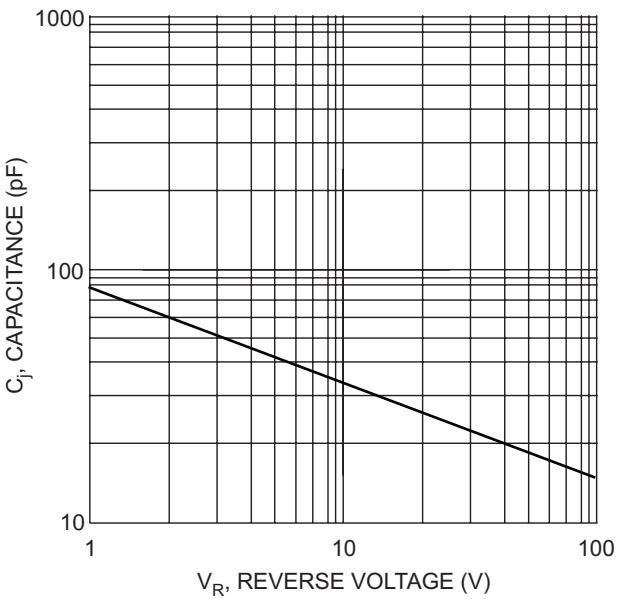
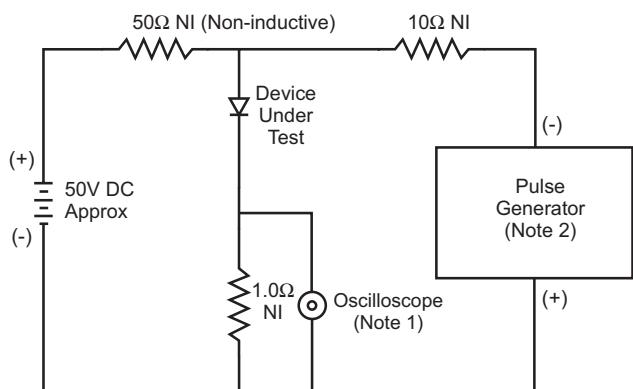


Fig. 4 Typical Junction Capacitance



Notes:

1. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.
2. Rise Time = 10ns max. Input Impedance = 50Ω.

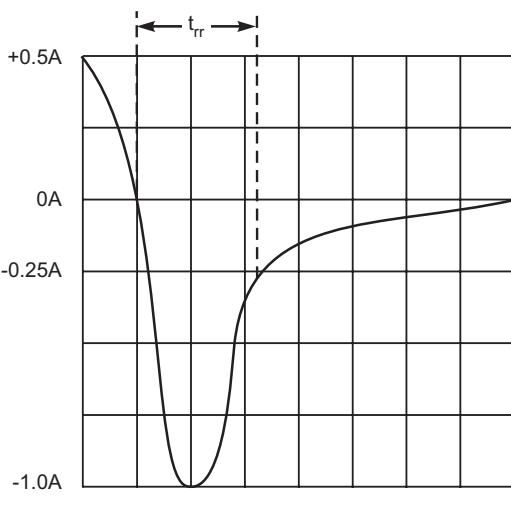


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit